1 • T eSIM (eUICC)

MFF2/EMBEDDED

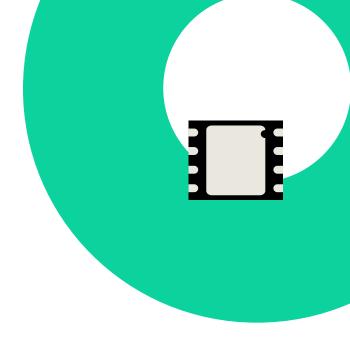
TECHNICAL DATA SHEET

Hardware Features

- Operating temperature: -40 to 105 °C
- Data Retention: 17 years at 85°C; 10 years at 105°C
- Erase/Write Cycles : 500.000 cycles
- 30 Kbytes of user RAM
- Up to 1280 Kbytes of user Flash memory with OTP area
- 1.8 V, 3 V and 5 V supply voltage ranges
- Current consumption compatible with GSM and ETSI specifications
- Power-saving standby state
- Contact assignment compatible with ISO/IEC 7816-2
- ESD protection greater than 4 kV (HBM)
- Industrial qualification (JEDEC)

Security Features

- Active shield
- Memory protection unit (MPU)
- Monitoring of environmental parameters
- Protection against faults
- 16- and 32-bit CRC calculation block (ISO 13239, IEEE 802.3, etc.)



- True random number generator
- Hardware security-enhanced
 DES accelerator
- Hardware security-enhanced AES accelerator
- NESCRYPT coprocessor for public key cryptography algorithm

Software features

- 2G/3G Rel12 (U)SIM Main Features
- JavaCard and GlobalPlatform Features
- ISIM Features
- Dynamic Memory Management
- OTA and BIP/CAT-TP Features
- EAP Methods



